

X -> [X] is attached hereto.

BOX(ES) -> [ ] was filed on \_\_\_\_\_ as U.S. Application No. 0\_/\_

-> [ ] was filed as PCT International Application No. PCT/ / on

-> -> and (if U.S. or PCT application amended) was amended on

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. 1.56. I hereby claim foreign priority benefits under 35 U.S.C. 119/365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate filed by me or my assignee disclosing the subject matter claimed in this application and having a filing date (1) before that of the application on which priority is claimed, or (2) if no priority claimed, before the filing date of this application:

PRIOR FOREIGN APPLICATION(S)

<u>Number</u>	<u>Country</u>	<u>Day/MONTH/Year Filed</u>	<u>Date first laid open or Published</u>	<u>Date Patented or Granted</u>	<u>Priority Claimed</u>	<u>No</u>
2000-75906	Japan	March 17, 2000			Yes	X
2001-59002	Japan	March 2, 2001			X	

I hereby claim domestic priority benefit under 35 U.S.C. 119/120/365 of the indicated United States applications listed below and PCT international applications listed above or below and, if this is a continuation-in-part (CIP) application, insofar as the subject matter disclosed and claimed in this application is in addition to that disclosed in such prior applications, I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. 1.56 which became available between the filing date of each such prior application and the national or PCT international filing date of this application:

PRIOR U.S. PROVISIONAL, NONPROVISIONAL AND/OR PCT APPLICATION(S)

<u>Application No. (series code/serial no.)</u>	<u>Day/MONTH/Year Filed</u>	<u>Status</u>	<u>Priority Claimed</u>
		<u>pending, abandoned, patented</u>	<u>Yes</u> <u>No</u>

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

And I hereby appoint Pillsbury Madison & Sutro LLP, Intellectual Property Group, 1100 New York Avenue, N.W., Ninth Floor, East Tower, Washington, D.C. 20005-3918, telephone number (202) 861-3000 (to whom all communications are to be directed), and the below-named persons (of the same address) individually and collectively my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, and I hereby authorize them to delete names/numbers below of persons no longer with their firm and to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/ organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct the above Firm and/or a below attorney in writing to the contrary.

Paul N. Kokulis	16773	Dale S. Lazar	28872	Mark G. Paulson	30793	Michael R. Dzwonczyk	36787
Raymond F. Lippitt	17519	Paul E. White, Jr.	32011	Stephen C. Glazier	31361	W. Patrick Bengtsson	32456
G. Lloyd Knight	17698	Glenn J. Perry	28458	Paul F. McQuade	31542	Jack S. Barufka	37087
Carl G. Love	18781	Kendrew H. Colton	30368	Ruth N. Morduch	31044	Adam R. Hess	41835
Kevin E. Joyce	20508	G. Paul Edgell	24238	Richard H. Zaitlen	27248		
George M. Sirilla	18221	Lynn E. Eccleston	35861	Roger R. Wise	31204		
Donald J. Bird	25323	Timothy J. Klima	34852	Jay M. Finkelstein	21082		
Peter W. Gowdey	25872	David A. Jakopin	32995	Anita M. Kirkpatrick	32617		

1. INVENTOR'S SIGNATURE: Hideki Hibino Date March 6, 2009  
 Inventor's Name (typed) Hideki Hibino Japan  
 First Middle Initial Family Name Country of Citizenship

Residence (City) Kariya-shi, Aichi-ken (State/Foreign Country) Japan  
Post Office Address (Include Zip Code) c/o DENSO CORPORATION, 1-1, Showa-cho, Kariya-city, Aichi-pref. 448-0029 Japan

2. INVENTOR'S SIGNATURE: Toshimi Miyamoto Date March 7, 2001  
 Inventor's Name (typed) Toshimi Miyamoto Japan  
     First Middle Initial Family Name Country of Citizenship  
 Residence (City) Okazaki-shi, Aichi-ken (State/Foreign Country) Japan  
 Post Office Address (Include Zip Code) c/o DENSO CORPORATION, 1-1, Showa-cho, Kariva-city, Aichi-pref. 448-0029 Japan

**3. INVENTOR'S SIGNATURE:** \_\_\_\_\_ Date \_\_\_\_\_  
Inventor's Name (typed) \_\_\_\_\_  

First                  Middle Initial                  Family Name                  Country of Citizenship

(State/Foreign Country)

  
Residence (City) \_\_\_\_\_  
Post Office Address (Include Zip Code) \_\_\_\_\_

(FOR ADDITIONAL INVENTORS, check box ☐ and attach sheet (PAT-116.2) for same information for each re signature, name, date, citizenship, residence and address.)